Boron Heavy Doping and Simultaneous Doping with Boron and Oxygen for Si Molecular Beam Epitaxy

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Recently interests of heavy doping of B with usual Knudsen cell have been growing for Si molecular beam epitaxy (MBE). We have been using sintered BN plates combined with B2O3 and B doping level up to 7×10^{19} cm⁻³ was realized at crucible temperature of $1350~\rm oC.1$) Ostrom and Allen used pure B2O3 and highest boron level was 3×10^{19} cm⁻³ at crucible temperature of $1100~\rm oC$ and they reported the evaporating molecule was B2O3(g).2) But higher doping level did not attained because of the temperature limit of crucible. Then we used HBO2 source,

H2O-absorbed B2O3 powder, as evaporating material. Maximum carrier concentration has reached 6x1020 cm⁻³ at crucible temperature of 900 °C. Still more, to obtain heavily doped and wide band-gap material that is important for the wide band-gap emitter of Si bipolar transistors, we tried simultaneous doping with B and O. The Ultra-Violet (UV) irradiation during growth was found to enhance O doping.

Experiments were performed in Si MBE system (ANELVA 430) which has the spurazil viewing port at cell port for UV irradiation from a 500W Hg-Xe lamp.

Figure 1 shows carrier concentration dependence on crucible temperature, where the growth rate was 10 Å/s and the growth temperature was 700 °C. Si films were doped from two different boron sources, sintered plates of BN combined with B2O3, which was already reported1), and H2O-absorbed B2O3 powder. B might evaporate in the form of HBO2 in the latter case. Figure 2 shows the comparison of vapor pressure between B2O3 and HBO2. The activation energy (Ea) for doping from sintered BN plates with B2O3 was 5.4 eV which is close to Ea of B2O3 and in the case of the B2O3 powder, Ea was 1.6 eV which is close to that of HBO2. The vapor pressure of HBO2 is 10^5 times larger than that of B2O3 at 900 °C. Then the higher doping could be realized at the lower crucible temperature.

Figure 3 shows ultra-violet reflection spectra of B doped films from H2O-absorbed B2O3 powder source with and without UV irradiation during growth. The growth rate was 0.5 Å/s and the

growth temperature was 850 °C. The carrier concentration was 1×10^{20} cm⁻³. In the case of doped film, the peaks of transition of $\Gamma_{35}' - \Gamma_{15}$ and $X_4 - X_1$ shift toward longer wave length comparison with bulk Si. This shift becomes larger with UV irradiation. According with AES depth profle measurement, O peak was observed in the film grown with UV irradiation but was observed without UV irradiation. This means that O atoms evaporate with B, get into epitaxial layer and change Si irradiation may accelerate this reaction, but it structure. UV was not determined how electrical band-gap of Si changed. Further analysis is now in progress. There was no UV irradiation effect on the carrier concentration change.

In conclusion, high doping level of B up to $6x10\ 20\ cm^{-3}$ was realized in Si MBE utilizing HBO2 ,source (H2O-absorbed B2O3 powder). Oxygen doping was effectively attained by UV irradiation.

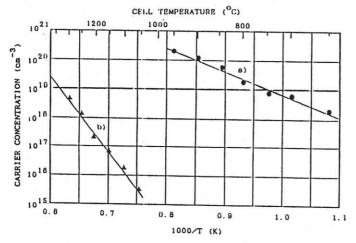


Fig.1 The carrier concentration dependence on crucible temperature doped from a) pure B₂O₃ powder and b) sintered plates of BN combined with B₂O₃

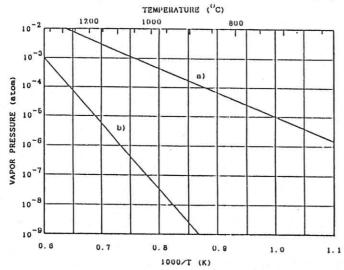


Fig. 2 The vapor pressure of a) HBO2 and b) B2O3

References

- 1)N. Aizaki and T. Tatsumi, Extended Abstracts of the 17th Conference on Solid State Devices and Materials, Tokyo 1985, pp. 301-304.
- 2)R.M.Ostrom and F.G.Allen, Appl.Phys.Lett.48(3)(1986)221.

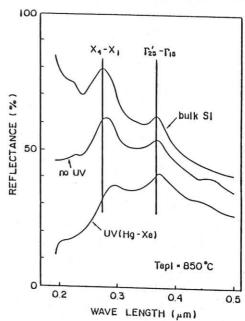


Fig.3 The ultra-violet reflection spectra of B doping films with or without UV irradiation